ThinkStation P330 Tower Gen 2 30CY007JUS

Product ThinkStation P330 Tower Gen 2

Region NA

Country/Region

Machine Type 30CY

TopSeller TopSeller

Processor Intel Xeon E-2224 4C/4T/3.4GHz/8MB/71W/DDR4-2666

Integrated Graphics None

Discrete Graphics NVIDIA Quadro P5000 16GB

Chipset Intel C246

HDD Controller Onboard Intel RSTe SATA RAID

M.2 SSD RAID Controller Onboard Intel RSTe PCIe

Memory 1x 16GB UDIMM DDR4-2666 ECC

Internal Disk Drive None

M.2 SSD Drive 1x 512GB SSD M.2 PCIe NVMe Opal

Optane Memory None

Optical 1x 9.0mm DVD±RW

Media Reader SD Reader

Ethernet 1x GbE RJ-45

WLAN + Bluetooth None

Optional Front Ports None

Optional Rear Ports None

Chassis Intrusion Switch None

Cover Lock

Cable Lock None

Dust Filter

None

Keyboard USB Traditional Keyboard, Black, English

Mouse USB Calliope Mouse

Power Supply 400W Platinum Fixed

System Management Intel vPro with AMT 12

Operating System Windows 10 Pro 64 for Workstations, English

Bundled Software None

Base Warranty 3-year, Onsite

Bundled Service

EAN / UPC / JAN 194632678727

End of Support 2026-08-24

Announce Date 2019-12-10

Recommended Services

Best

4Y Lenovo Protect (Premier Support + Keep Your Drive + Accidental Damage Protection) (5PS0N73191)

Better

4Y Lenovo Support (Premier Support + Keep Your Drive) (5PS0N73243)

Good

3Y Premier Support Upgrade from 3Y Onsite (5WS0U26646)

Notes:

California Electronic Waste Recycling Fee

In California, per state law, Lenovo charges an electronic waste recycling fee on this covered device at the time of sale of the product. For more information, go to: https://www.calrecycle.ca.gov/Electronics/Consumer

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ThinkStation P330 Tower Gen 2 (30CY and 30D0) Platform Specifications - I of II

Product Specifications Reference (PSREF)

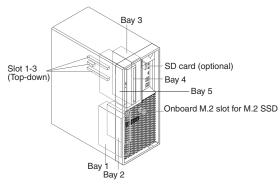
Lenovo

Components	Specification		Components	Specification					
Form factor	18L Tower			Up to two PCIe 3.0 x16 slots for discrete graphics card (Slot 1 and 3).					
Dimensions	Height: 376 mm (14	4.8 in). Width: 165 mm (6.5 in). Depth: 328 mm (12.9 in)		Supports the following graphics adapters:					
Weight		ation: 23.37 lb (10.6kg)	1	Graphics			nector	Max Qty	
	Supports one of the following processors:		-1	Quadro P400	2GB wGDDI		niniDP	2	
I				Quadro P620	2GB GDDR		niniDP	2	
I	Xeon E-2286G	6C/12T/4.0GHz/12MB/95W/DDR4-2666 400W PSU needed	Discrete Graphics	Quadro P1000	4GB GDDR		niniDP	2	
	Xeon E-2278G	8C/16T/3.4GHz/16MB/80W/DDR4-2666 400W PSU needed	Offering	Quadro P2000	5GB GDDR			2	
	Xeon E-2276G Xeon E-2274G	6C/12T/3.8GHz/12MB/80W/DDR4-2666		Quadro P2200	5GB GDDR			2	
	Xeon E-2274G Xeon E-2246G	4C/8T/4.0GHz/8MB/83W/DDR4-2666 6C/12T/3.6GHz/12MB/80W/DDR4-2666		Quadro P4000	8GB GDDR			1 2 1	
	Xeon E-2246G Xeon E-2244G	4C/8T/3.8GHz/8MB/71W/DDR4-2666		Quadro P5000		15X 180W DVI-D D			
	Xeon E-2236	6C/12T/3.4GHz/12MB/80W/DDR4-2666		Quadro RTX 400	000 8GB GDDR6 160W 3x DP, 1x VirtualLink 1				
	Xeon E-2234	4C/8T/3.6GHz/8MB/71W/DDR4-2666		Note: 2x Quadro P20	000, Quadro P4000, Qua			ads 400W/ PC	υ I
	Xeon E-2226G	6C/6T/3.4GHz/12MB/80W/DDR4-2666			, ,				RAID
Processor	Xeon E-2224G	4C/4T/3.5GHz/8MB/71W/DDR4-2666	Storage Controller	Storage Controll	ler Typ ST SATA RAID Sto		Disk Ty HDD or S		0/1/10/5
	Xeon E-2224	4C/4T/3.4GHz/8MB/71W/DDR4-2666					M.2 PCle		0/1
	Xeon E-2186G								
	Xeon E-2174G	4C/8T/3.8GHz/8MB/71W/DDR4-2666		Disk Type	Interface RPM			Max Qty	۲ <u>ــــــــــــــــــــــــــــــــــــ</u>
	Core i9-9900K	8C/16T/3.6GHz/16MB/95W/DDR4-2666 400W PSU needed			SATA 6Gb/s 7.2K			3	
	Core i9-9900	8C/16T/3.1GHz/16MB/65W/DDR4-2666	Storage Support		SATA 6Gb/s 7.2K			4	
	Core i7-9700K	8C/8T/3.6GHz/12MB/95W/DDR4-2666 400W PSU needed		2.5" SATA SSD		256GB/512GB/1	18	4	
	Core i7-9700	8C/8T/3.0GHz/12MB/65W/DDR4-2666		Optane Memory	PCIe NVMe	32GB	1100	1, d with HDD	חפפער
	Core i7-8700K	6C/12T/3.7GHz/12MB/95W/DDR4-2666		M.2 PCle SSD		256GB/512GB/1		<u>a wiin HDL</u> 3	0,000
	Core i7-8700	6C/12T/3.2GHz/12MB/65W/DDR4-2666	╟────					<u> </u>	
	Core i5-9600K	6C/6T/3.7GHz/9MB/95W/DDR4-2666 400W PSU needed		Up to five bays	with four disk bays 1x 2.5" SSD, or 4x	pius one slim opt	ical bay, s	supports u	ip to 3x
		Core i5-9600 6C/6T/3.1GHz/9MB/65W/DDR4-2666 Core i5-9500 6C/6T/3.0GHz/9MB/65W/DDR4-2666 Core i5-9400F 6C/6T/2.9GHz/9MB/65W/DDR4-2666 Core i5-9400 6C/6T/2.9GHz/9MB/65W/DDR4-2666							
					disk bay, 3.5" or 2.				
				Bay 2 2.5" SATA bay, cannot be available when 2nd Quadro P2000 is used					
	Core i5-8500	6C/6T/3.0GHz/9MB/65W/DDR4-2666			ry disk bay, 3.5" or				
	Core i3-9300				ex bay, supports on				
	Core i3-9100	4C/4T/3.6GHz/6MB/65W/DDR4-2400	Storage Bays		odule for optional f			=F1394	
	Core i3-8300	4C/4T/3.7GHz/8MB/62W/DDR4-2400			k bay, 3.5" or 2.5",				<u>, </u>
	Core i3-8100	4C/4T/3.6GHz/6MB/65W/DDR4-2400							·
Chipset	Intel C246 Chipset		7	Enclosure, using SATA 4 connector as eSATA mode 3rd disk bay, 3.5" or 2.5", via 5.25" to 3.5" HDD Kit					
Memory Sockets	4 DIMM sockets with	2 channels	1	Bay 5 9mm Slin		140.20 100.0 F			
	8GB/16GB DDR4-2666 UDIMM ECC or		1			DCIe to M.O!-	tor)		
Memory Types	4GB/8GB/16GB/32GB DDR4-2666 UDIMM non-ECC		Madia		SD (1 onboard. 2 via				
Memory Capacity		for UDIMM ECC or 128GB with 4 x 32GB UDIMM non-ECC	Media reader		card reader on mo			10121	
		UDIMM ECC memeory	Network	One onboard G	bE port via integra	ted gigabit ethern	et Intel i2	19LM, sup	oports
Expansion slots	Three PCIe 3.0 slots as following:		interfaces		Optional PCIe ethe				
	Slot 1 PCle 3.0 x16, full height, half length, links to CPU		WLAN + Bluetooth	2.4GHz/5GHz (onboard M.2 slot for 160MHz channels	5 optional Intel W	oth 5 un	5 9560, 2x 1 to 1 73G	x2, bps
	Slot 2 PCIe 3.0 x1, full height, full length, links to PCH		1	Power-on and a	dmin password. Tr	usted Platform Mc	odule. TC	G 2.0 com	npliant.
	Slot 3 PCIe 3.0 x16 (negotiable link width x4), full height, half length, links to PCH		Security features	Optional chassis	s intrusion switch,	E-lock, cable lock,	Kensing	ton lock, a	ind pad
Processor graphics	Integrated Intel UHD Graphics P630 in -G suffix Xeon processors, or Intel UHD Graphics 630 in Core i7, i5, i3, or Pentium processors. Works along with discrete graphics to support multi-display, enables three rear		╣	lock	Due e M			1-	
			Intel vPro	Supports Intel v	Pro on Xeon and s	selected Core i7 o	r 15 mode	IS.	
					res Wireless-AC 95				
	display connectors	(2 DP standard, 1 DP or HDMI optional)	Intel AMT	Intel Active Man	nagement Technolo Manageability on o	bgy 12 on Xeon m	odels,		
		<u> </u>			nes with 3-year limi		with Ove		
			Base warranty	<u>1 or 3-y</u> ear limite	ed onsite service v	vith 9x5/NBD in El	MEA or o	ther GEOs	S
			HD Audio		nterface with Realf				

ThinkStation P330 Tower Gen 2 (30CY and 30D0) Platform Specifications - II of II

Components	Specification				
Front ports	2x USB 3.1 Gen 1 Type A. 2x USB 3.1 Gen 2 Type A. 1x USB 3.1 Gen 1 Type-C. 1x Mic-in. 1x Combo jack				
Rear ports	2x USB 3.1 Gen 1 Type A. 2x USB 2.0 Type-A. 1x RJ-45. 1x COM. 2x DP. 1x Audio line-out Notes: DP needs Core, Pentium, or -G suffix Xeon processor				
Optional front ports (on flex module)	2x Thunderbolt (USB Type-C), one of two ports supports video-out. 1x eSATA. 1x IEEE1394				
Optional rear ports	Supports the following via cable: 1x COM. 1x Parallel. 2x PS/2. 1x DP or 1x HDMI. 2x USB 2.0 Supports the following via PCIe adapter: 4x COM. 2x USB 3.1 Type-C. 2x USB 3.1 Gen 1. 1x Thunderbolt. Notes: DP or HDMI needs Core, Pentium, or -G suffix Xeon processor				
Temperature	Operating: 50 °F to 95 °F (10 °C to 35 °C) Non operating (no package): 14 °F to 140 °F (-10 °C to 60 °C) Non operating (with package): -40 °F to 140 °F (-40 °C to 60 °C)				
Altitude	Operating: -15.2 m (-50 ft) to 3048 m (10 000 ft). Storage: -15.2 m (-50 ft) to 10, 668 m (35 000 ft)				
Humidity	Operating: 30%~90%, non-condensing Storage (with package): 20%~90%, non-condensing				
Environmental certification	RoHS-compliant. GREENGUARD. EPEAT Silver rating and ENERGY STAR 7 gualified				
Power supply	Supports one 250W or 400W power supply, 100V - 240V, 92% PSU. Climate Savers Computing Platinum and 80 PLUS Platinum qualified. 400W PSU supports one 6+2-pin aux power connector.				
ISV certifications	Please visit www.thinkworkstations.com/isv-certifications/				

Note: 1. Depending on many factors, actual data transfer speed mentioned on this page may be lower than theoretical speed. 2. Any questions or advice on ThinkStation PSREF, please contact ThinkStation PSREF developer



ThinkStation P330 Tower Gen 2











